

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-400	V
Collector-Emitter Voltage	V _{CEO}	-400	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-0.5	A
Peak Pulse Current	I _{CM}	-1	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

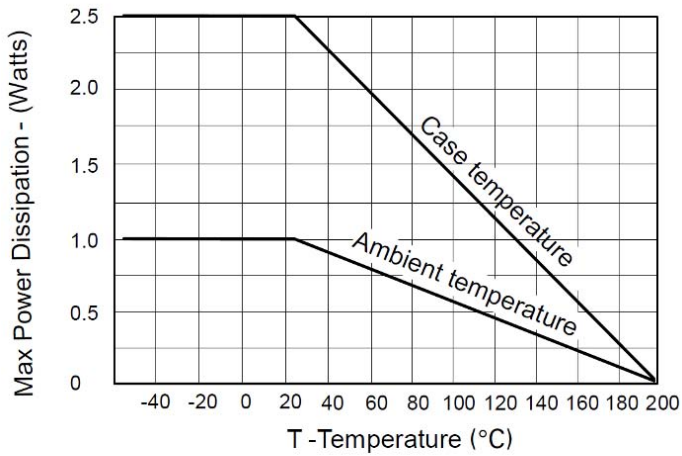
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	1.5	W
Power Dissipation (Note 6)	P _D	1	W
Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	116	°C/W
Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	175	°C/W
Thermal Resistance Junction to Lead (Note 7)	R _{θJL}	70	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +200	°C

ESD Ratings (Note 8)

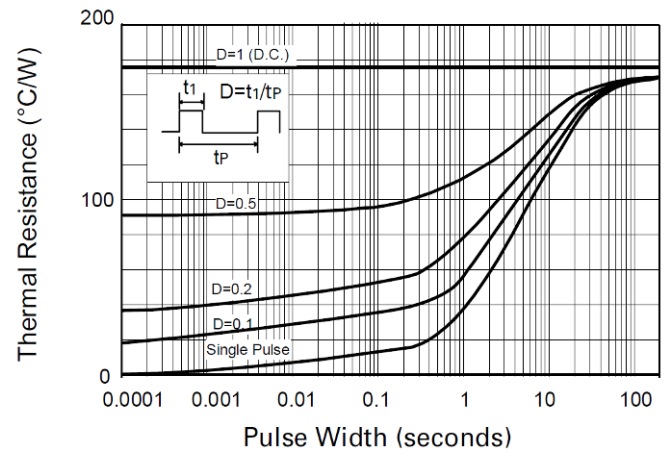
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	≥ 4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	C

- Notes:
- For a through-hole device mounted at the seating plane (2.5mm lead length) with the collector lead on 25mm x 25mm 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.
 - Same as note (5), except the device is mounted on minimum recommended pad layout with 12mm lead length from the bottom of package to the board.
 - Thermal resistance from junction to solder-point at the seating plane (2.5mm from the bottom of package along the collector lead).
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

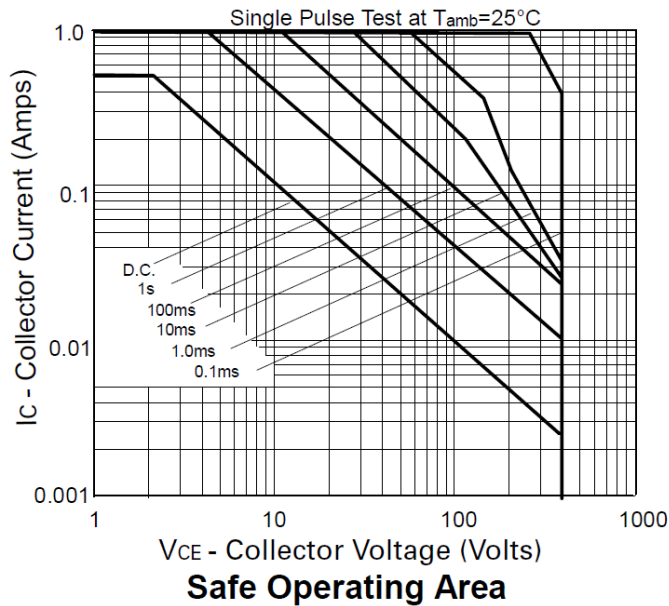
Thermal Characteristics and Derating Information



Derating curve



Maximum transient thermal impedance



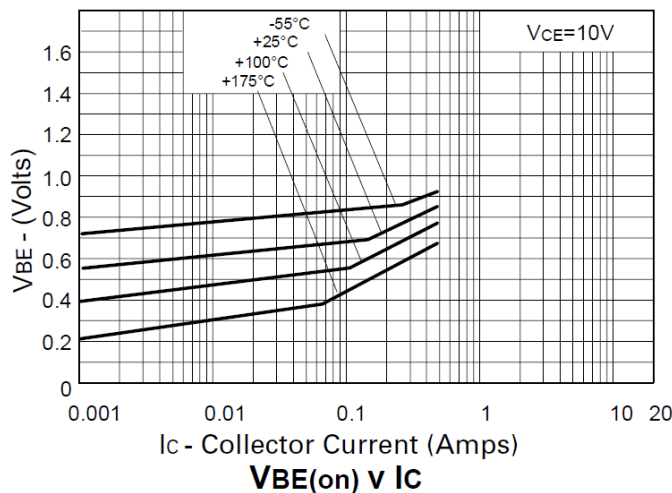
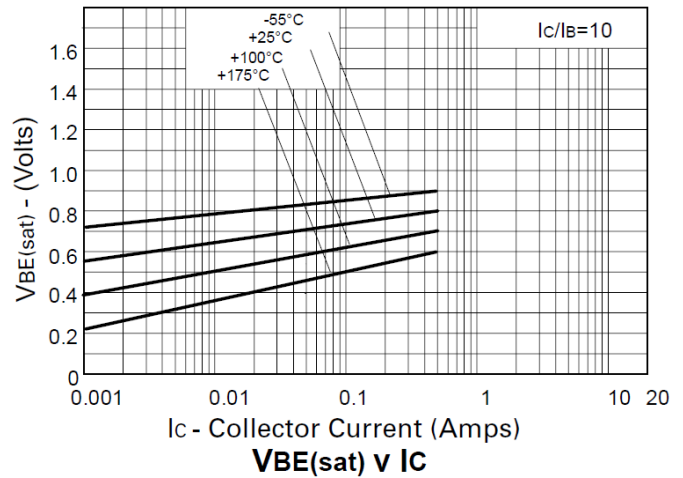
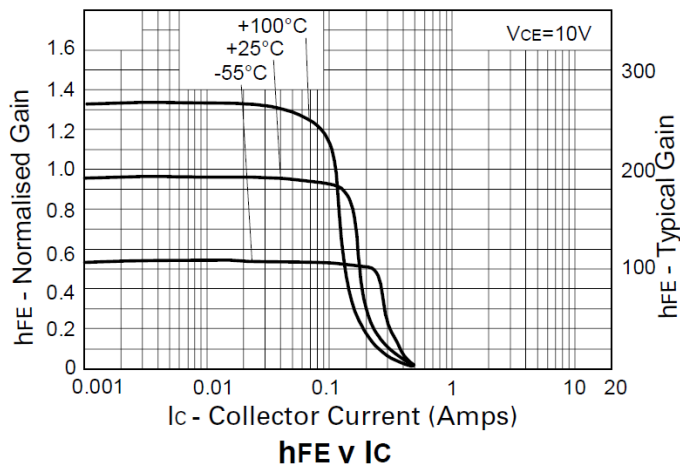
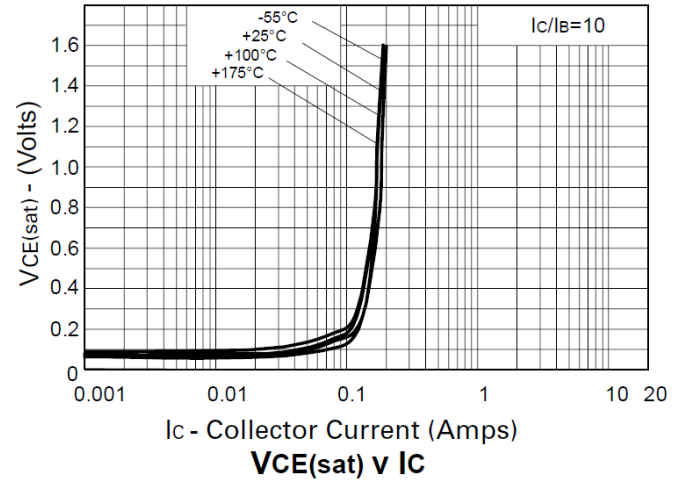
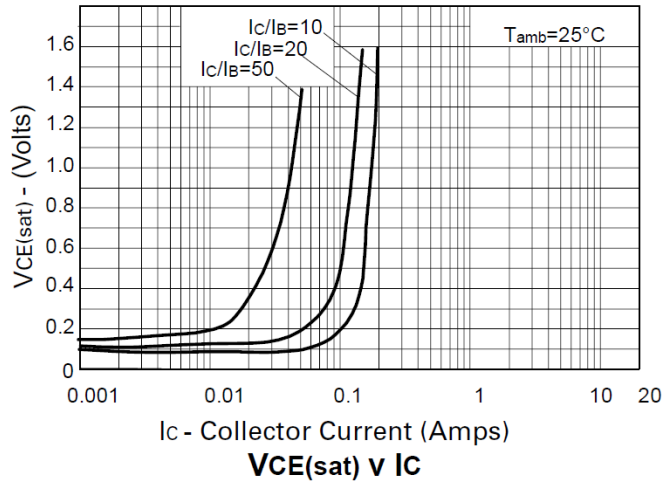
Safe Operating Area

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-400	—	—	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-400	—	—	V	I _C = -1mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	—	—	V	I _E = -100μA
Collector Cut-off Current	I _{CBO}	—	—	-100	nA	V _{CB} = -320V
Emitter Cut-off Current	I _{EBO}	—	—	-100	nA	V _{EB} = -6V
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(sat)}	—	—	-300 -250 -500	mV	I _C = -20mA, I _B = -1mA I _C = -50mA, I _B = -5mA I _C = -100mA, I _B = -10mA
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	—	—	-0.9	V	I _C = -100mA, I _B = -100mA
Base-Emitter Turn-On Voltage (Note 9)	V _{BE(on)}	—	—	-0.9	V	I _C = -100mA, V _{CE} = -5V
DC Current Gain (Note 9)	h _{FE}	50 50 40	—	—	—	I _C = -1mA, V _{CE} = -5V I _C = -100mA, V _{CE} = -5V I _C = -200mA, V _{CE} = -10V
Current Gain-Bandwidth Product (Note 9)	f _T	50	—	—	MHz	V _{CE} = -20V, I _C = -20mA f = 20MHz
Output Capacitance (Note 9)	C _{obo}	—	—	20	pF	V _{CB} = -20V, f = 1MHz
Turn-On Times	t _{on}	—	140	—	ns	I _C = -100mA, I _{B1} = 10mA, I _{B2} = -20mA, V _C = -100V
Turn-Off Times	t _{off}	—	2000	—	ns	

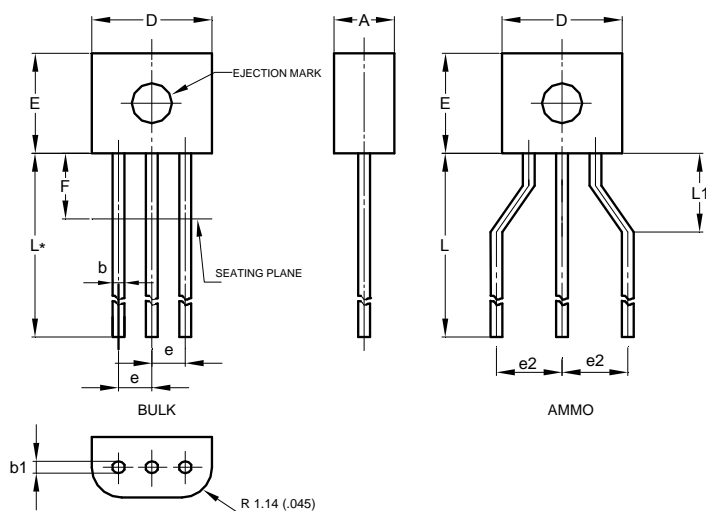
Note: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



E-Line			
Dim	Min	Max	Typ
A	2.16	2.41	—
b	0.41	0.495	—
b1	0.41	0.495	—
D	4.37	4.77	—
E	3.61	4.01	—
e	—	—	1.27
e2	—	—	2.54
F	—	2.50	—
L	13.00	13.97	—
L1	2.50	3.50	—
All Dimensions in mm			

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